

PM017N100AG



POWERCUBESEMI, INC.

Potential · Convergence · Smart

100V 60A 17mΩ Si Single N-ch Enhancement Mode Power MOSFET with Normal Diode

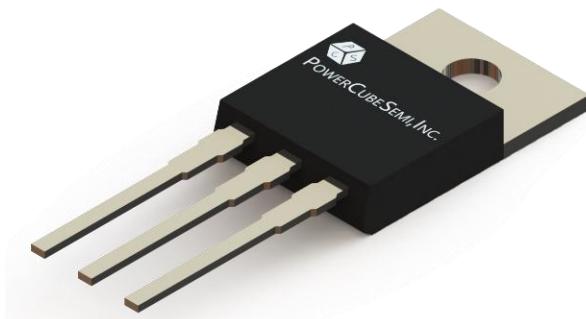
Features

Si Single N-ch Enhancement Mode Power MOSFET

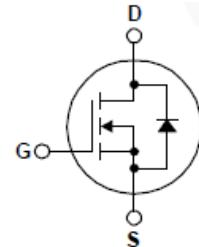
- Rated to 100V at 60Amps @ $T_J = 25^\circ\text{C}$
- Max $R_{DS(\text{on})} = 17 \text{ m}\Omega$
- Typ $R_{DS(\text{on})} = 14 \text{ m}\Omega$
- Gate Charge(Typ. $Q_g=146 \text{ nC}$)
- 100% Avalanche Tested

Application

- Power switch
- DC/DC Converter



PKG type : TO-220



Description

The PM017N100AG uses advanced trench technology to provide excellent $R_{DS(\text{ON})}$, low gate charge. it can be used in a wide variety of applications.

Absolute Maximum Ratings

Symbol	Parameter	Test Condition	Value	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}$, $I_D=250\mu\text{A}$	100	V
I_D	Drain Current	$T_c=25^\circ\text{C}$	60	A
I_{DM}	Pulsed Drain Current	Pulse width limited by junction temperature	240	A
V_{GS}	Gate-Source Voltage		± 20	V
E_{AS}	Single Pulsed Avalanche Energy	$V_{DD}=50\text{V}$, $V_{GS}=10\text{V}$, $L=0.5\text{mH}$, $R_G=25\Omega$	100	mJ
P_d	Power Dissipation	$T_c=25^\circ\text{C}$	132	W
T_j	Operating Junction Temperature		150	°C
T_{stg}	Storage Temperature		-55 to 150	°C



Package Marking and Ordering Information

Device Marking	Device	Package	Packing Method	Tape width	Quantity
PM017N100AG	PM017N100	TO-220	TUBE	-	50 ea

Electrical Characteristics of Si MOSFET

Symbol	Parameter	Test Condition	Numerical			Unit
			Min	Typ.	Max.	
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A, T_J = 25^\circ C$	100	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 100V, V_{GS} = 0V$	-	-	1	μA
I_{GSS}	Gate-Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	± 100	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu A$	0.8	1.7	2.5	V
$R_{DS(ON)}$	Static Drain-Source on state resistance	$V_{GS} = 10V, I_D = 20A$	-	14	17	$m\Omega$
g_{FS}	Forward Transconductance	$V_{DS} = 5V, I_D = 20A$	-	32	-	S
$t_{d(on)}$	Turn-on Delay time	$V_{DS} = 50V, I_D = 20A, R_G = 2.5\Omega$	-	17	-	ns
T_r	Turn-on Rise time		-	13	-	
$t_{d(off)}$	Turn-off Delay time		-	55	-	
T_f	Turn-off Fall time		-	16	-	



Electrical Characteristics of Si MOSFET

Symbol	Parameter	Test Condition	Numerical		Unit
			Typ.	Max.	
$R_{\theta JC}$	Thermal Resistance, Junction to Case		0.94	-	°C/W
C_{iss}	Input Capacitance	$V_{DS} = 50V, V_{GS} = 0V, f = 1.0MHz$	5986	-	pF
C_{oss}	Output Capacitance		176	-	
C_{rss}	Reverse Transfer Capacitance		164	-	
$Q_{g(tot)}$	Total Gate Charge at 10V	$V_{DS} = 50V, I_D = 20A, V_{GS(on)} = 10V$	146	-	nC
Q_{gs}	Gate to Source Gate Charge		29	-	
Q_{gd}	Gate to Drain "Miller" Charge		57	-	

Electrical Characteristics of Si Diode

Symbol	Parameter	Test Condition	Numerical		Unit
			Typ.	Max.	
I_S	Maximum Continuous Drain to Source Diode Forward Current		-	60	A
V_{SD}	Drain to Source Diode Forward Voltage	$I_{SD} = 20A, V_{GS} = 0V$	-	1.2	V
T_{rr}	Reverse Recovery Time	$I_F = 20A, V_{GS} = 0V, dI_F/dt=100A/\mu s$	35	-	ns
Q_{rr}	Reverse Recovery Charge		58	-	nC

Typical Characteristics

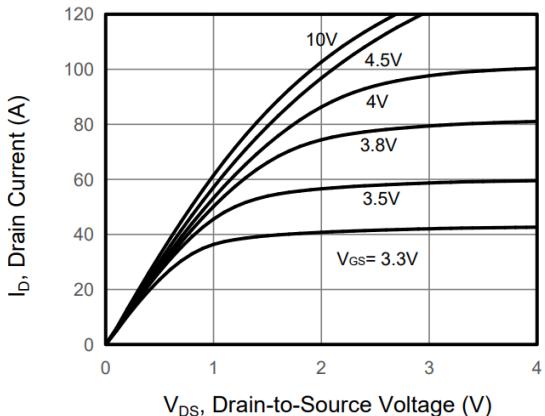


Figure 1. Output Characteristics

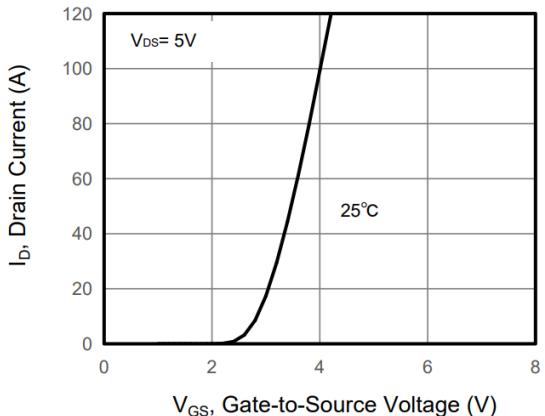


Figure 2. Transfer Characteristics

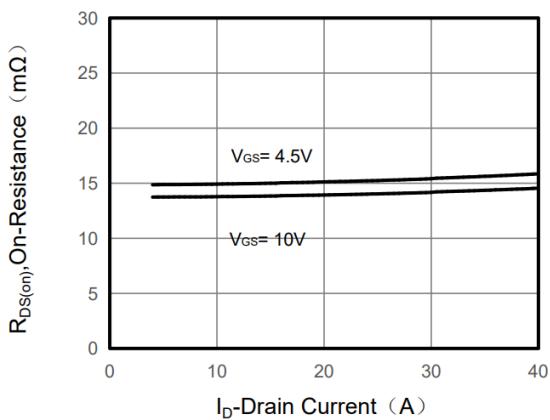


Figure 3. Drain to Source On-Resistance

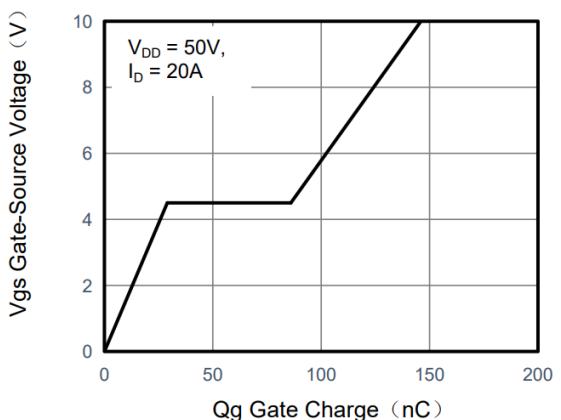


Figure 4. Gate Charge

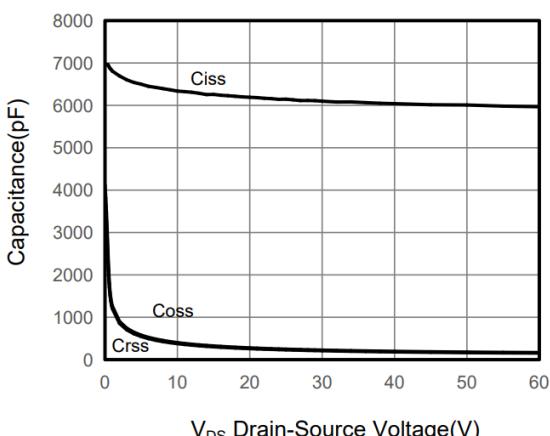


Figure 5. Capacitance Characteristics

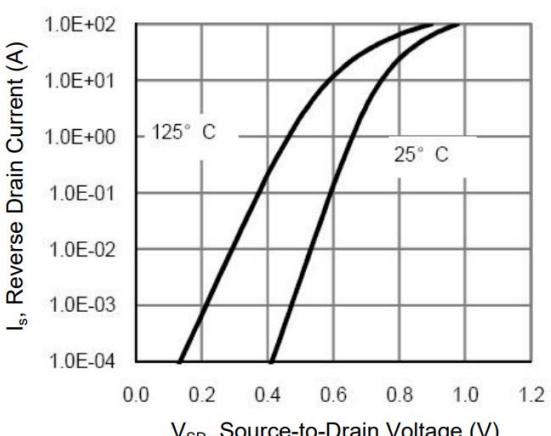


Figure 6. Source to Drain Diode Forward

Typical Characteristics

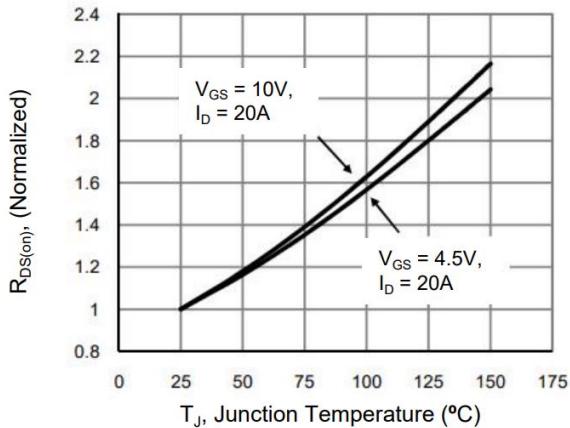


Figure 7. Drain to Source On-Resistance

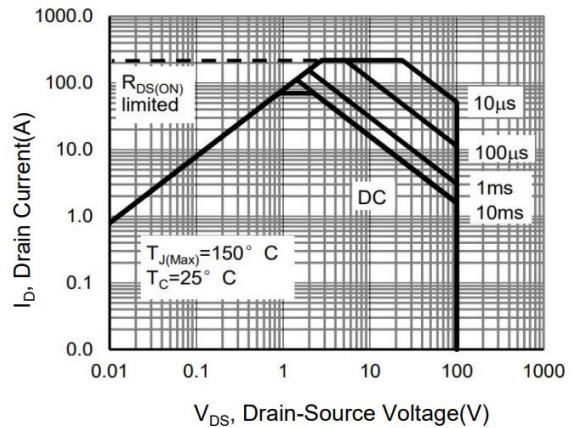


Figure 8. Safe Operation Area

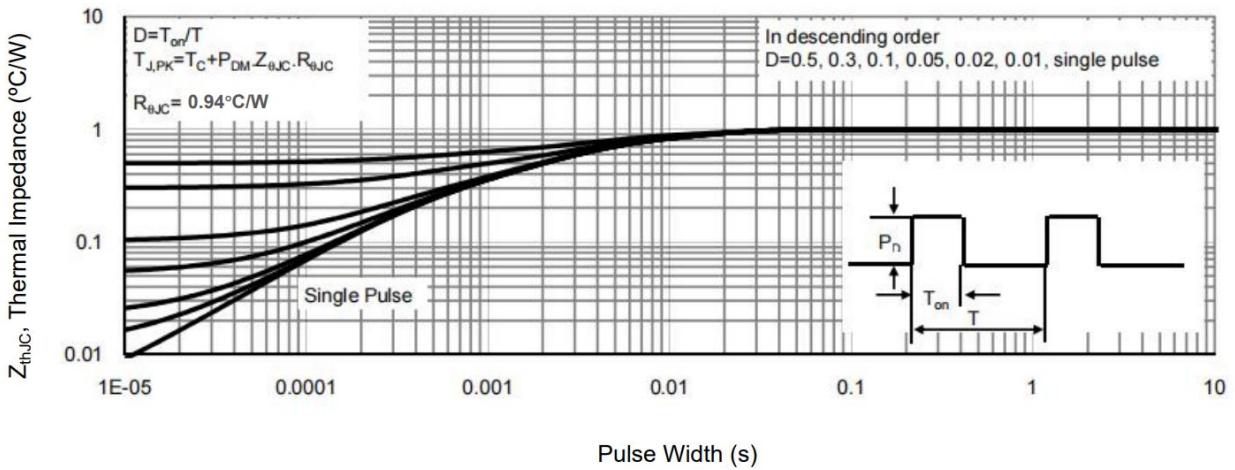


Figure 9. Normalized Maximum Transient Thermal Impedance



Package Outline

Unit : mm

